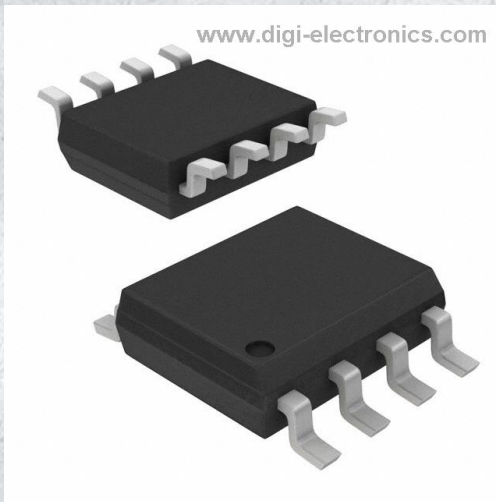


# FDS8842NZ Datasheet



<https://www.DiGi-Electronics.com>

DiGi Electronics Part Number	FDS8842NZ-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	FDS8842NZ
Description	MOSFET N-CH 40V 14.9A 8SOIC
Detailed Description	N-Channel 40 V 14.9A (Ta) 2.5W (Ta) Surface Mount 8-SOIC



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RFQ Email: [Info@DiGi-Electronics.com](mailto:Info@DiGi-Electronics.com)

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## Purchase and inquiry

Manufacturer Product Number:

FDS8842NZ

Series:

PowerTrench®

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

40 V

Drive Voltage (Max Rds On, Min Rds On):

4.5V, 10V

Vgs(th) (Max) @ Id:

3V @ 250µA

Vgs (Max):

±20V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

8-SOIC

Base Product Number:

FDS8842

Manufacturer:

onsemi

Product Status:

Active

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

14.9A (Ta)

Rds On (Max) @ Id, Vgs:

7mOhm @ 14.9A, 10V

Gate Charge (Qg) (Max) @ Vgs:

73 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

3845 pF @ 15 V

Power Dissipation (Max):

2.5W (Ta)

Mounting Type:

Surface Mount

Package / Case:

8-SOIC (0.154", 3.90mm Width)

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

1 (Unlimited)

ECCN:

EAR99



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**FAIRCHILD**  
SEMICONDUCTOR®

**FDS8842NZ**

**N-Channel PowerTrench® MOSFET**

**40 V, 14.9 A, 7.0 mΩ**

### Features

- Max  $r_{DS(on)}$  = 7.0 mΩ at  $V_{GS} = 10$  V,  $I_D = 14.9$  A
- Max  $r_{DS(on)}$  = 11.6 mΩ at  $V_{GS} = 4.5$  V,  $I_D = 11.6$  A
- HBM ESD protection level of 4.4 kV typical(note 3)
- High performance trench technology for extremely low  $r_{DS(on)}$  and fast switching
- High power and current handling capability
- Termination is Lead-free and RoHS Compliant



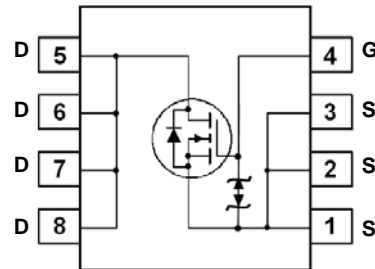
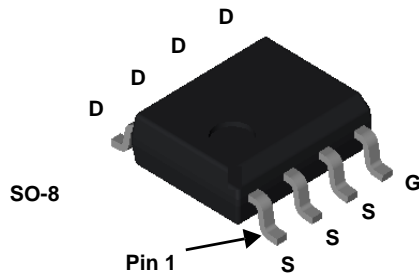
February 2009

### General Description

The FDS8842NZ has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance.

### Applications

- Synchronous Buck for Notebook Vcore and Server
- Notebook Battery
- Load Switch



### MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain to Source Voltage	40	V
$V_{GS}$	Gate to Source Voltage	$\pm 20$	V
$I_D$	Drain Current -Continuous	14.9	A
	-Pulsed	93	
$E_{AS}$	Single Pulse Avalanche Energy (Note 4)	253	mJ
$P_D$	Power Dissipation $T_A = 25^\circ\text{C}$ (Note 1a)	2.5	W
	Power Dissipation $T_A = 25^\circ\text{C}$ (Note 1b)	1.0	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

### Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case (Note 1)	25	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8842NZ	FDS8842NZ	SO8	13"	12 mm	2500 units

FDS8842NZ N-Channel Power Trench® MOSFET

**Electrical Characteristics**  $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**Off Characteristics**

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 250\ \mu\text{A}$ , $V_{GS} = 0\ \text{V}$	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , referenced to $25\text{ }^\circ\text{C}$		35		mV/ $^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 32\ \text{V}$ , $V_{GS} = 0\ \text{V}$			1	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 20\ \text{V}$ , $V_{DS} = 0\ \text{V}$			$\pm 10$	$\mu\text{A}$

**On Characteristics**

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\ \mu\text{A}$	1.0	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , referenced to $25\text{ }^\circ\text{C}$		-6		mV/ $^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\ \text{V}$ , $I_D = 14.9\ \text{A}$		5.6	7.0	m $\Omega$
		$V_{GS} = 4.5\ \text{V}$ , $I_D = 11.6\ \text{A}$		6.7	11.6	
		$V_{GS} = 10\ \text{V}$ , $I_D = 14.9\ \text{A}$ , $T_J = 125\text{ }^\circ\text{C}$		8.9	11.1	
$g_{FS}$	Forward Transconductance	$V_{DS} = 5\ \text{V}$ , $I_D = 14.9\ \text{A}$		111		S

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 15\ \text{V}$ , $V_{GS} = 0\ \text{V}$ , $f = 1\ \text{MHz}$		2890	3845	pF
$C_{oss}$	Output Capacitance			340	455	pF
$C_{rss}$	Reverse Transfer Capacitance			220	330	pF
$R_g$	Gate Resistance		$f = 1\ \text{MHz}$		0.8	

**Switching Characteristics**

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 20\ \text{V}$ , $I_D = 14.9\ \text{A}$ , $V_{GS} = 10\ \text{V}$ , $R_{GEN} = 6\ \Omega$		13	23	ns
$t_r$	Rise Time			7	14	ns
$t_{d(off)}$	Turn-Off Delay Time			34	54	ns
$t_f$	Fall Time			5	10	ns
$Q_g$	Total Gate Charge	$V_{GS} = 0\ \text{V}$ to $10\ \text{V}$	$V_{DD} = 20\ \text{V}$ , $I_D = 14.9\ \text{A}$	52	73	nC
$Q_g$	Total Gate Charge	$V_{GS} = 0\ \text{V}$ to $5\ \text{V}$		27	38	nC
$Q_{gs}$	Gate to Source Charge			8.6		nC
$Q_{gd}$	Gate to Drain "Miller" Charge			9.7		nC

**Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0\ \text{V}$ , $I_S = 14.9\ \text{A}$		0.8	1.2	V
		$V_{GS} = 0\ \text{V}$ , $I_S = 2.1\ \text{A}$		0.7	1.2	
$t_{rr}$	Reverse Recovery Time	$I_F = 14.9\ \text{A}$ , $di/dt = 100\ \text{A}/\mu\text{s}$		26	42	ns
$Q_{rr}$	Reverse Recovery Charge			15	27	nC

## NOTES:

- $R_{\theta JA}$  is determined with the device mounted on a  $1\ \text{in}^2$  pad 2 oz copper pad on a  $1.5 \times 1.5\ \text{in.}$  board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a)  $50\text{ }^\circ\text{C}/\text{W}$  when mounted on a  $1\ \text{in}^2$  pad of 2 oz copper.



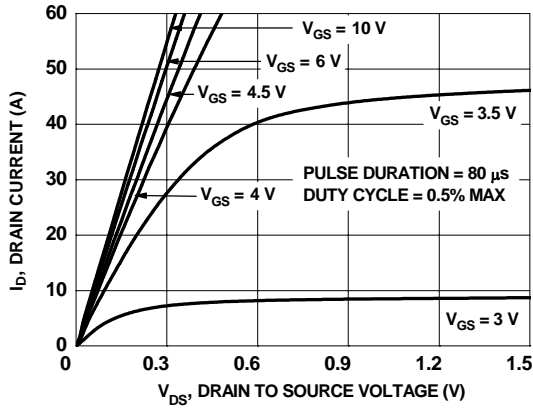
b)  $125\text{ }^\circ\text{C}/\text{W}$  when mounted on a minimum pad.

2. Pulse Test: Pulse Width  $< 300\ \mu\text{s}$ , Duty cycle  $< 2.0\%$ .

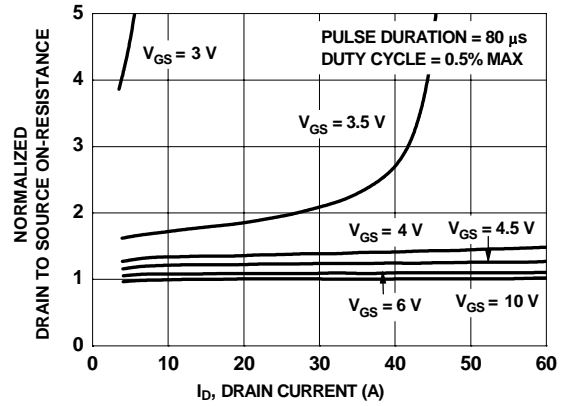
3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

4. Starting  $T_J = 25\text{ }^\circ\text{C}$ ,  $L = 3\ \text{mH}$ ,  $I_{AS} = 13\ \text{A}$ ,  $V_{DD} = 40\ \text{V}$ ,  $V_{GS} = 10\ \text{V}$ .

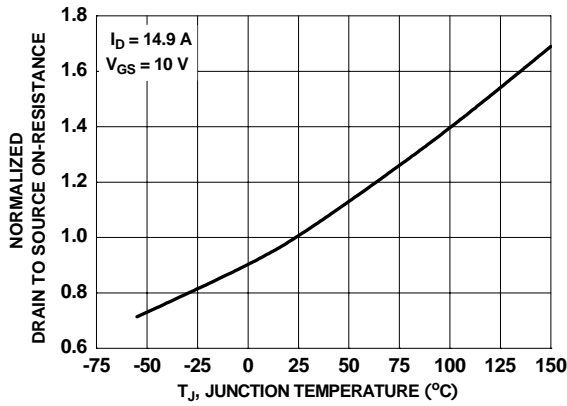
**Typical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted



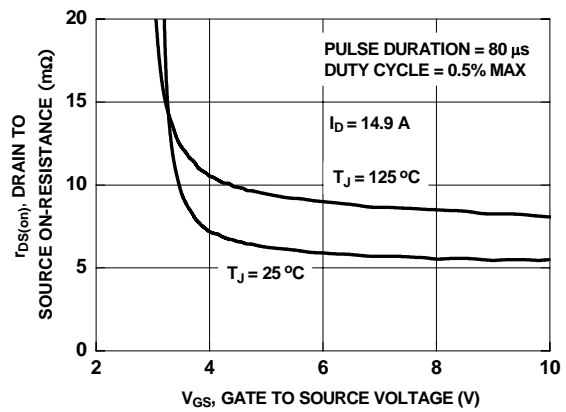
**Figure 1. On-Region Characteristics**



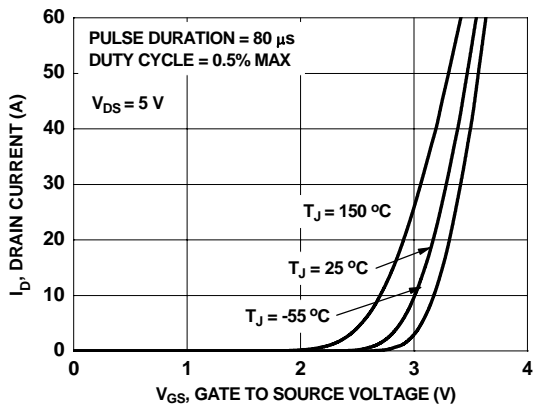
**Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage**



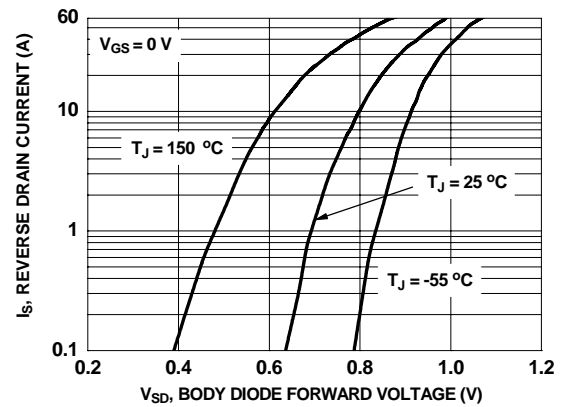
**Figure 3. Normalized On-Resistance vs Junction Temperature**



**Figure 4. On-Resistance vs Gate to Source Voltage**

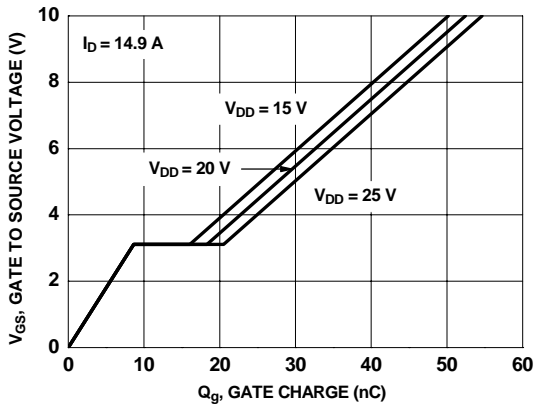


**Figure 5. Transfer Characteristics**

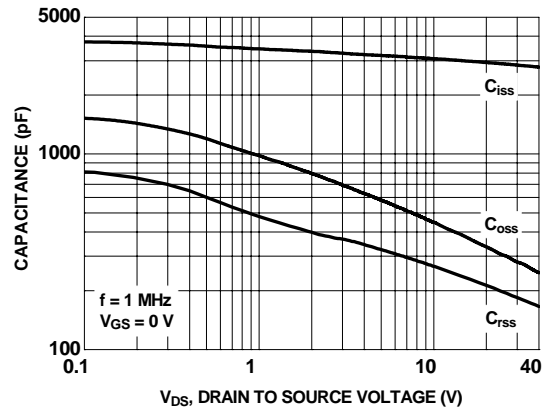


**Figure 6. Source to Drain Diode Forward Voltage vs Source Current**

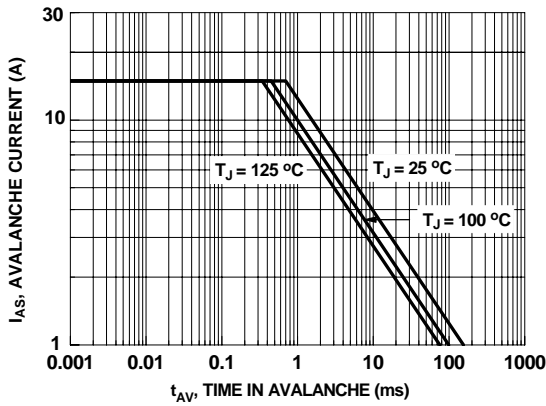
**Typical Characteristics**  $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted



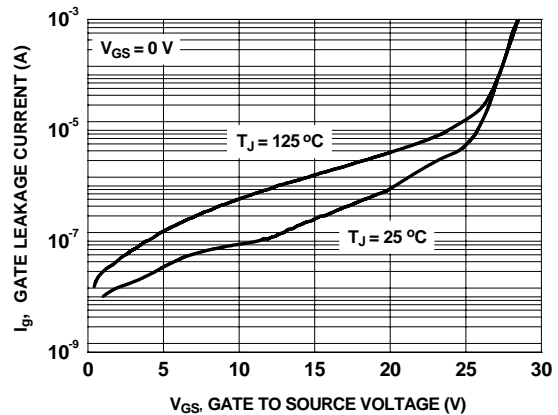
**Figure 7. Gate Charge Characteristics**



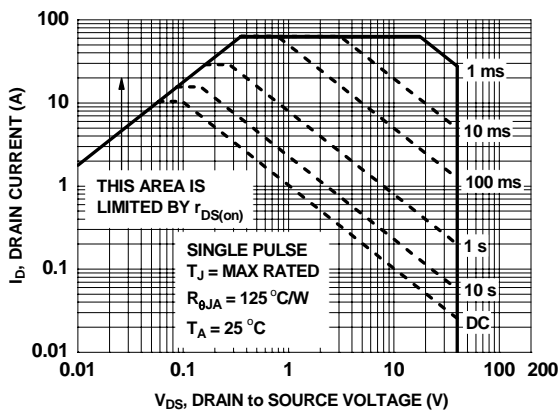
**Figure 8. Capacitance vs Drain to Source Voltage**



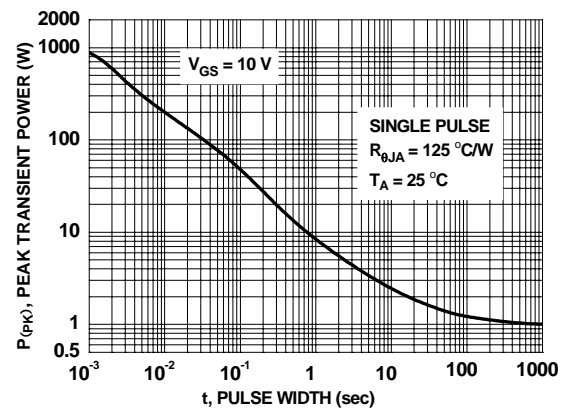
**Figure 9. Unclamped Inductive Switching Capability**



**Figure 10.  $I_{gss}$  vs  $V_{gs}$**

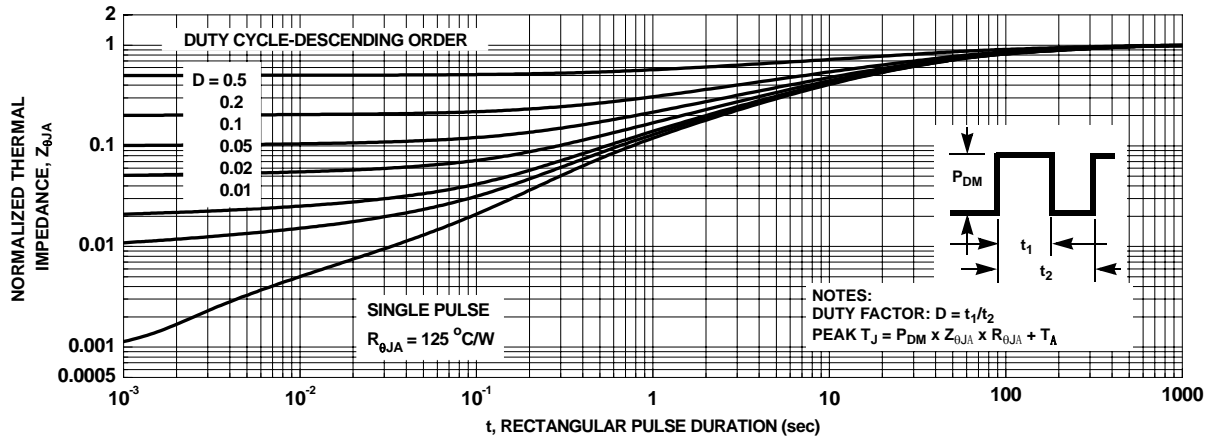


**Figure 11. Forward Bias Safe Operating Area**



**Figure 12. Single Pulse Maximum Power Dissipation**

**Typical Characteristics**  $T_J = 25\text{ }^\circ\text{C}$  unless otherwise noted





**Figure 13. Transient Thermal Response Curve**





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